



100V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)} max	I _D max T _A = +25°C		
400) (110mΩ @ V _{GS} = 10V	3.6A		
100V	122mΩ @ V _{GS} = 6.0V	3.4A		

Description

This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- DC-DC Converters
- Power Management Functions

Features and Benefits

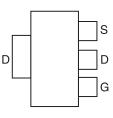
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

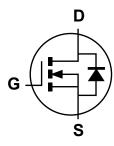
- Case: SOT223
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.112 grams (Approximate)



Top View



Pin Out - Top View



Equivalent Circuit

Ordering Information (Note 4)

Part Number	Qualification	Case	Packaging
DMN10H120SE-13	Standard	SOT223	2,500/Tape & Reel

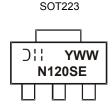
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information





Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage			V _{DSS}	100	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 6) V _{GS} = 10V	Steady State	T _A = +25°C T _A = +70°C	I _D	3.6 2.9	А
Pulsed Drain Current (10 μ s pulse, duty cycle \leq 1%)	I _{DM}	16	A		
Maximum Body Diode Continuous Current (Note 6)			IS	2.5	A

Thermal Characteristics (@T_A = $\pm 25^{\circ}$ C, unless otherwise specified.)

Characteristic	Symbol	Value	Units	
Total Dowar Dissinction	(Note 5)	D	1.3	w
Total Power Dissipation	(Note 6)	P _D	2.1	
Thermal Decistores Junction to Ambient	(Note 5)		94	°C/W
Thermal Resistance, Junction to Ambient	(Note 6)	R _{θJA}	58	
Thermal Resistance, Junction to Case	(Note 6)	R _{θJC}	8.2	
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C	

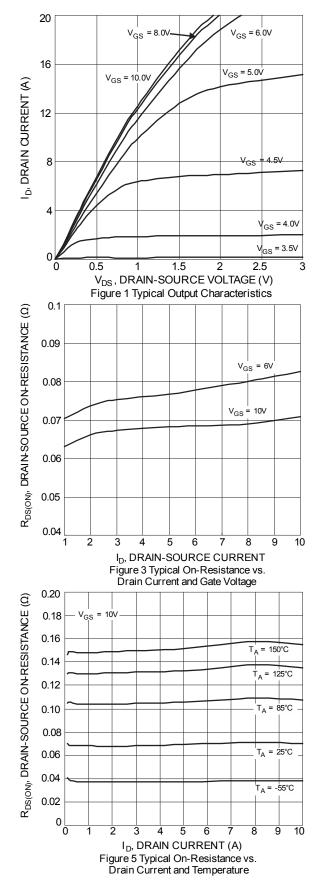
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

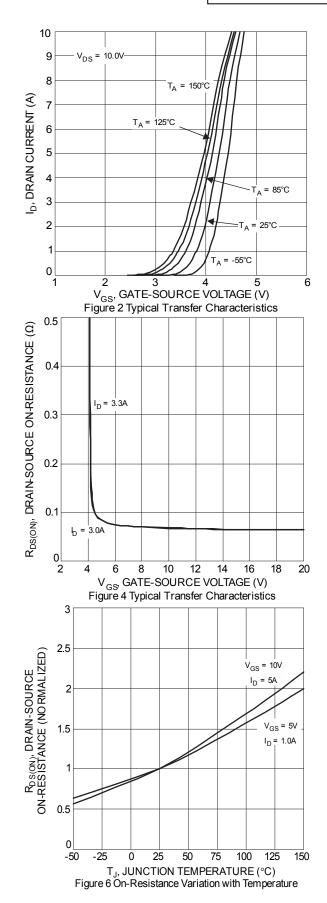
Characteristic	Symbol	Min	Тур	Мах	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)	Gymbol		. 76	mux	•		
Drain-Source Breakdown Voltage	BV _{DSS}	100			V	V _{GS} = 0V, I _D = 250µA	
Zero Gate Voltage Drain Current	I _{DSS}			1.0	μA	V _{DS} = 80V, V _{GS} = 0V	
Gate-Body Leakage	I _{GSS}	_		±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(th)}	1.5	2.6	3.0	V	V_{DS} = V_{GS} , I_D = 250 μ A	
Static Drain-Source On-Resistance	р	_	77	110	mΩ	V _{GS} = 10V, I _D = 3.3A	
	R _{DS (ON)}	_	84	122	11122	V _{GS} = 6.0V, I _D = 3.0A	
Diode Forward Voltage	V _{SD}		0.8	1.2	V	V _{GS} = 0V, I _S = 3.2A	
DYNAMIC CHARACTERISTICS (Note 8)	·						
Input Capacitance	C _{iss}	_	549			V _{DS} = 50V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance	C _{oss}		41		pF		
Reverse Transfer Capacitance	C _{rss}	_	19				
Gate Resistance	Rg	_	1.6	_	Ω	VDS = 0V, VGS = 0V, f = 1.0MHz	
Total Gate Charge (V _{GS} = 10V)	Qg	_	10				
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	5.2		-0	V _{DS} = 50V, I _D = 3.3A	
Gate-Source Charge	Q _{gs}		2.3		nC		
Gate-Drain Charge	Q _{gd}		2.6				
Turn-On Delay Time	t _{D(on)}		3.8			V _{DD} = 50V, V _{GS} = 10V,	
Turn-On Rise Time	tr	_	1.8		nS		
Turn-Off Delay Time	t _{D(off)}	_	11		105	$R_{G} = 6.0\Omega, I_{D} = 3.3A$	
Turn-Off Fall Time	tf		2.5		1		
Reverse Recovery Time	t _{rr}		21		nS	V _{GS} = 0V, I _S =1.1A, di/dt=100A/µs	
Reverse Recovery Charge	Q _{rr}		17		nC	$v_{GS} = 0v, I_{S} = 1.1A, u/u_{L} = 100A/\mu_{S}$	

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing. Notes:



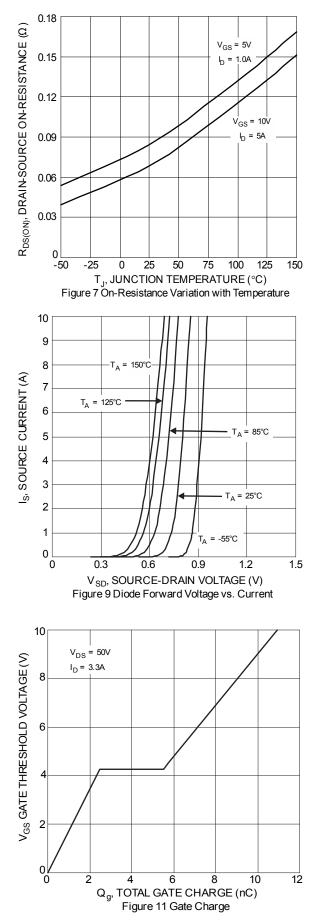
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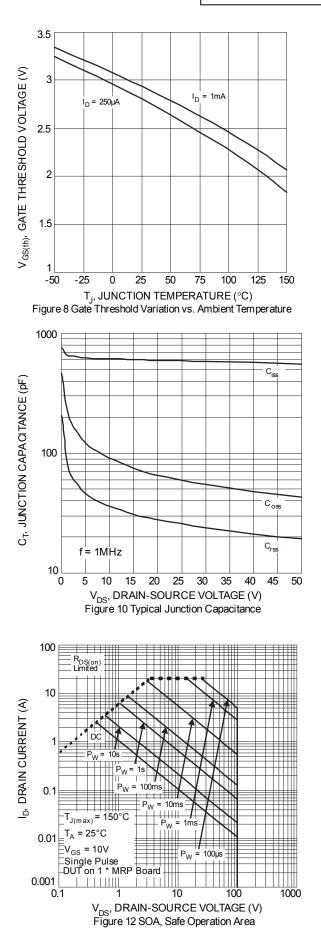




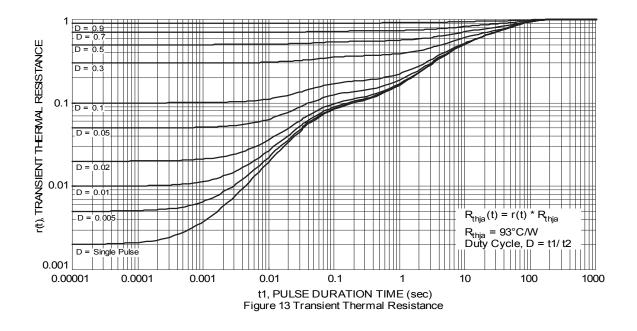


DMN10H120SE









Package Outline Dimensions & Suggested Pad Layout

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

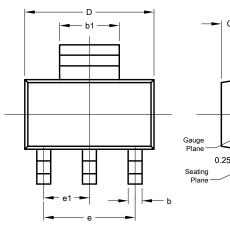
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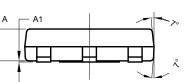
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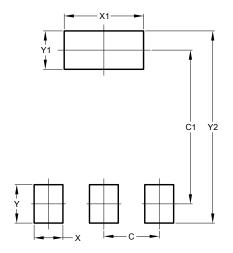


SOT223					
Dim	Min	Max	Тур		
Α	1.55	1.65	1.60		
A1	0.010	0.15	0.05		
b	0.60	0.80	0.70		
b1	2.90	3.10	3.00		
С	0.20	0.30	0.25		
D	6.45	6.55	6.50		
Е	3.45	3.55	3.50		
E1	6.90	7.10	7.00		
е	-	-	4.60		
e1	-	-	2.30		
L	0.85	1.05	0.95		
Q	0.84	0.94	0.89		
All Dimensions in mm					



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)			
С	2.30			
C1	6.40			
Х	1.20			
X1	3.30			
Y	1.60			
Y1	1.60			
C2	8.00			

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